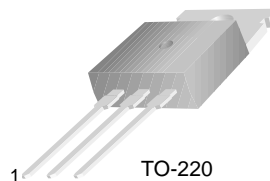


KSC5345

KSC5345

High Voltage and High Reliability

- High speed Switching
- Wide Safe Operating Area



TO-220
1.Base 2.Collector 3.Emitter

NPN Triple Diffused Planar Silicon Transistor

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	900	V
V_{CEO}	Collector-Emitter Voltage	450	V
V_{EBO}	Emitter-Base Voltage	14	V
I_C	Collector Current (DC)	5	A
I_{CP}	*Collector Current (Pulse)	10	A
I_B	Base Current (DC)	2	A
I_{BP}	*Base Current (Pulse)	4	A
P_C	Power Dissipation($T_C=25^\circ\text{C}$)	40	W
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	- 55 ~ 150	$^\circ\text{C}$

* Pulse Test: Pulse Width = 5ms, Duty Cycle \leq 10%

Thermal Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Characteristics		Rating	Unit
$R_{\theta jc}$	Thermal Resistance	Junction to Case	1.25	$^\circ\text{C/W}$
$R_{\theta ja}$		Junction to Ambient	62.5	

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = 500\mu\text{A}, I_E = 0$	900	-	-	V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 5\text{mA}, I_B = 0$	450	-	-	V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_C = 500\mu\text{A}, I_E = 0$	14	-	-	V
I_{CBO}	Collector Cut-off Current	$V_{CB} = 800\text{V}, I_E = 0$	-	-	10	μA
I_{EBO}	Emitter Cut-off Current	$V_{EB} = 14\text{V}, I_C = 0$	-	-	10	μA
h_{FE1} h_{FE2}	DC Current Gain	$V_{CE} = 5\text{V}, I_C = 0.6\text{A}$ $V_{CE} = 5\text{V}, I_C = 3\text{A}$	15 8	- -		
$V_{CE}(\text{sat})$	Collector-Emitter Saturation Voltage	$I_C = 3\text{A}, I_B = 0.6\text{A}$	-	-	1	V
$V_{BE}(\text{sat})$	Base-Emitter Saturation Voltage	$I_C = 3\text{A}, I_B = 0.6\text{A}$	-	-	1.5	V
C_{ob}	Output Capacitance	$V_{CB} = 10\text{V}, f = 1\text{MHz}$	-	65		pF
f_T	Current Gain bandwidth Product	$V_{CE} = 10\text{V}, I_C = 0.6\text{A}$	-	14	-	MHz
t_{STG}	Storage Time	$V_{CC} = 125\text{V}, I_C = 1\text{A}$		-	6.5	μs
t_F	Fall Time	$I_{B1} = -I_{B2} = 0.2\text{A}$	-	-	0.3	
t_{STG}	Storage Time	$V_{CC} = 250\text{V}, I_C = 4\text{A}$	-	-	3	μs
t_F	Fall Time	$I_{B1} = 0.8\text{A}, I_{B2} = -1.6\text{A}$	-	-	0.3	

Typical Characteristics

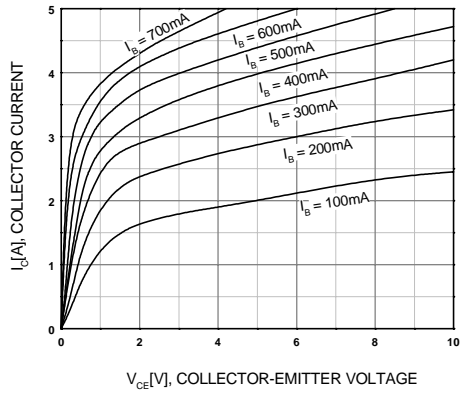


Figure 1. Static Characteristic

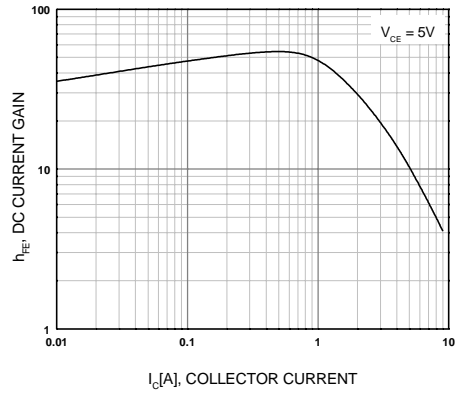


Figure 2. DC current Gain

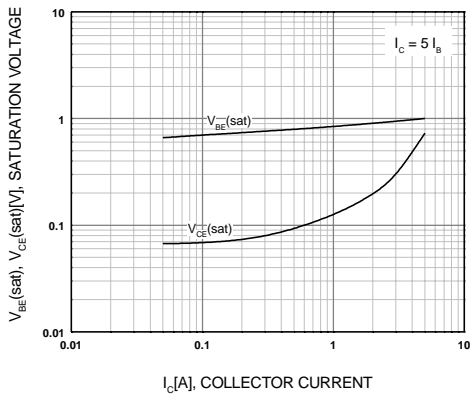


Figure 3. Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

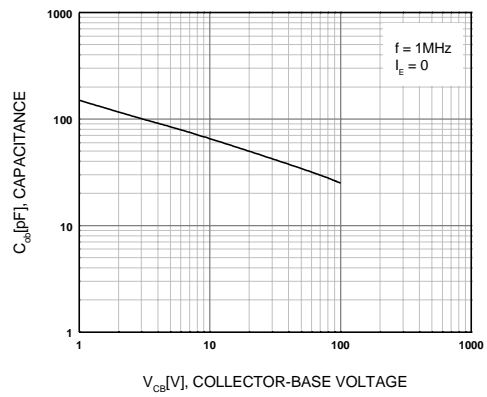


Figure 4. Collector Output Capacitance

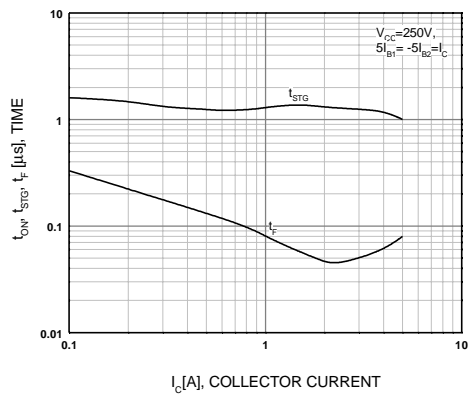


Figure 5. Switching Time

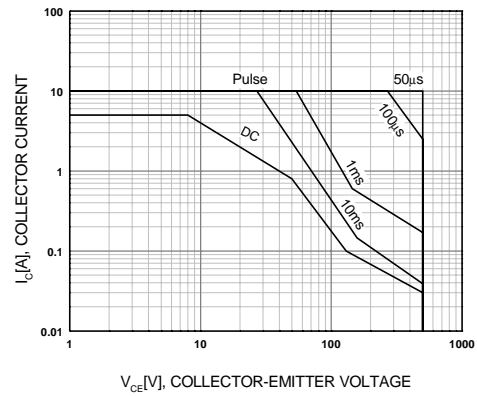


Figure 6. Safe Operating Area

Typical Characteristics (Continued)

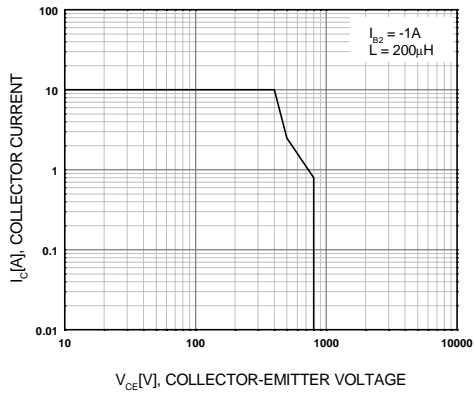


Figure 7. Reverse Bias Safe Operating Area

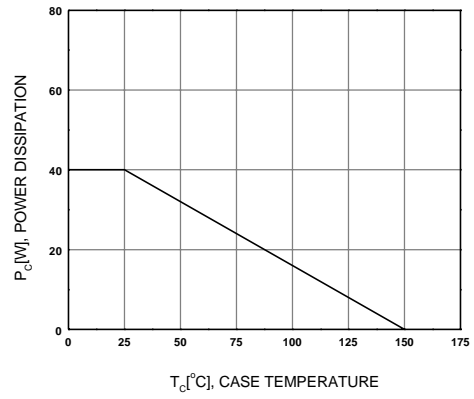
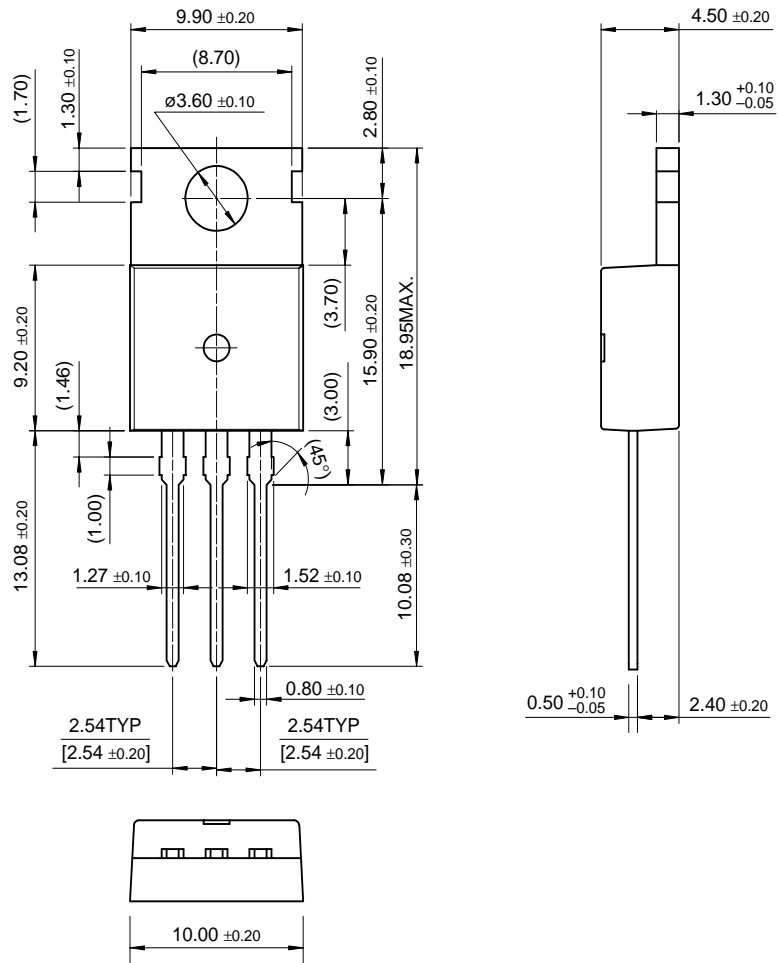


Figure 8. Power Derating

Package Dimensions

KSC5345

TO-220



Dimensions in Millimeters

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